ASSP

Dual Serial Input PLL Frequency Synthesizer

MB15F03

■ DESCRIPTION

The Fujitsu MB15F03 is a serial input Phase Locked Loop (PLL) frequency synthesizer with a 2.0GHz and a 500MHz prescalers. A 64/65 or a 128/129 for the 2.0GHz prescaler, and a 16/17 or a 32/33 for 500MHz prescaler can be selected that enables pulse swallow operation.

The latest BiCMOS process technology is used, resultantly a supply current is limited as low as 9.0mA typ. at a supply voltage of 3.0V.

Furthermore, a super charger circuit is included to provide a fast tuning as well as low noise performance. As a result of this, MB15F03 is ideally suitable for digital mobile communications, such as PHS(Personal Handy Phone System), PCN (Personal Communication Network) and PCS(Personal Communication Service).

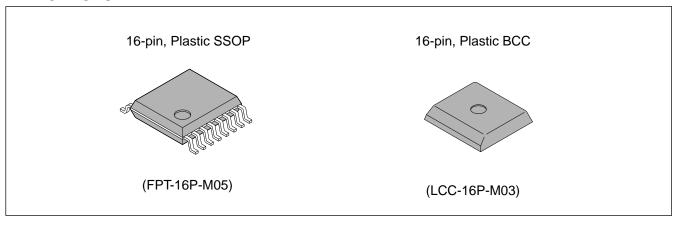
■ FEATURES

• High frequency operation RF synthesizer : 2.0GHz max.

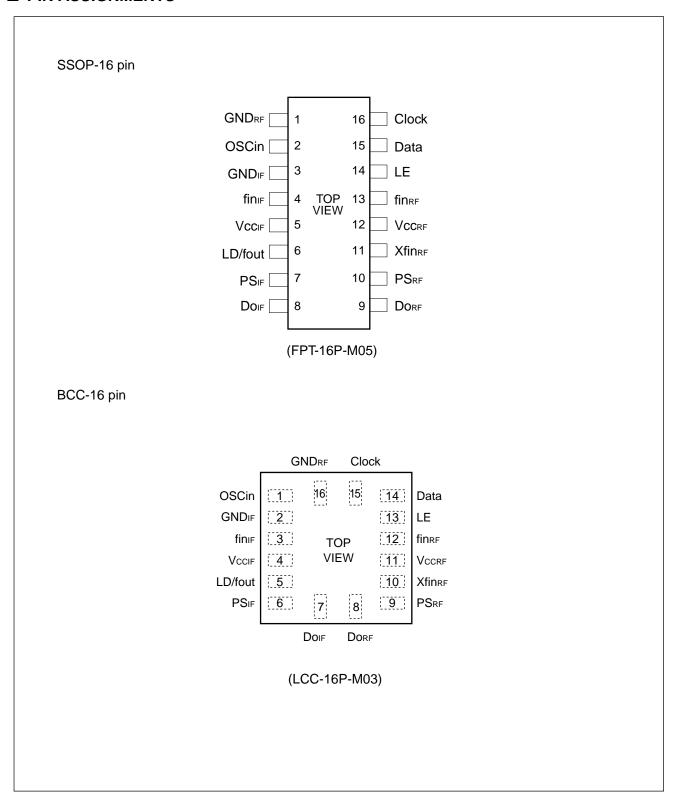
IF synthesizer : 500MHz max.

- Low power supply voltage: Vcc = 2.7 to 3.6V
- Very Low power supply current : Icc = 9.0 mA typ. (Vcc = 3V)
- Power saving function : I_{PS1} = I_{PS2} = 10 μA max.
- Serial input 14-bit programmable reference divider: R = 5 to 16,383
- Serial input 18-bit programmable divider consisting of:
 - Binary 7-bit swallow counter: 0 to 127
 - Binary 11-bit programmable counter: 5 to 2,047
- On-chip high performance charge pump circuit and phase comparator, achieving high-speed lock-up and low phase noise
- Wide operating temperature: Ta = −40 to 85°C
- Plastic 16-pin SSOP package (FPT-16P-M05) and 16-pin BCC package (LCC-16P-M03)

PACKAGES



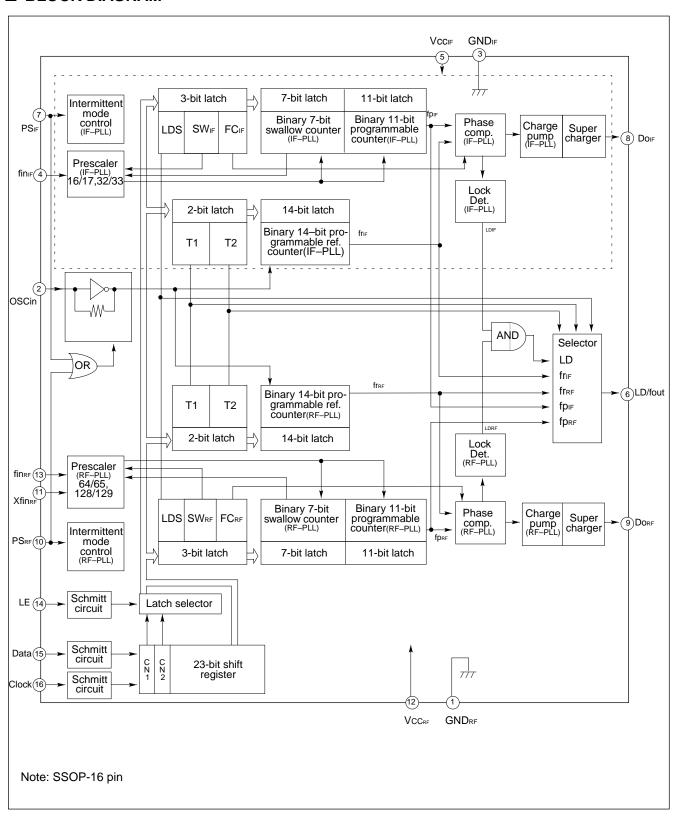
■ PIN ASSIGNMENTS



■ PIN DESCRIPTIONS

Pin No.		Pin	1/2	December 1 and a
SSOP	BBC	name	I/O	Descriptions
1	16	GNDrf	-	Ground for RF-PLL section.
2	1	OSCin	ı	The programmable reference divider input. TCXO should be connected with a coupling capacitor.
3	2	GNDıғ	_	Ground for the IF-PLL section.
4	3	finıF	I	Prescaler input pin for the IF-PLL. The connection with VCO should be AC coupling.
5	4	VCCIF	_	Power supply voltage input pin for the IF-PLL section. When power is OFF, latched data of IF-PLL is cancelled.
6	5	LD/fout	0	Lock detect signal output (LD) / phase comparator monitoring output (fout) The output signal is selected by a LDS bit in a serial data. LDS bit = "H"; outputs fout signal LDS bit = "L"; outputs LD signal
7	6	PSıF	I	Power saving mode control for the IF-PLL section. This pin must be set at "L" Power-ON. (Open is prohibited.) PS _{IF} = "H"; Normal mode PS _{IF} = "L"; Power saving mode
8	7	Doif	0	Charge pump output for the IF-PLL section. Phase characteristics of the phase detector can be reversed by FC-bit.
9	8	Dorf	0	Charge pump output for the RF-PLL section. Phase characteristics of the phase detector can be reversed by FC-bit.
10	9	PS _{RF}	I	Power saving mode control for the RF-PLL section. This pin must be set at "L" Power-ON. (Open is prohibited.) PSRF = "H"; Normal mode PSRF = "L"; Power saving mode
11	10	Xfin _{RF}	I	Prescaler complimentary input for the RF-PLL section. This pin should be grounded via a capacitor.
12	11	VCCRF	_	Power supply voltage input pin for the RF-PLL section, the shift register and the oscillator input buffer. When power is OFF, latched data of RF-PLL is cancelled.
13	12	fin _{RF}	I	Prescaler input pin for the RF-PLL. The connection with VCO should be AC coupling.
14	13	LE	I	Load enable signal input (with the schmitt trigger circuit.) When LE is "H", data in the shift register is transferred to the corresponding latch according to the control bit in a serial data.
15	14	Data	I	Serial data input (with the schmitt trigger circuit.) A data is transferred to the corresponding latch (IF-ref counter, IF-Prog. counter, RF-ref. counter, RF-prog. counter) according to the control bit in a serial data.
16	15	Clock	I	Clock input for the 23-bit shift register (with the schmitt trigger circuit.) One bit data is shifted into the shift register on a riging edge of the clock.

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit	Remark
Power supply voltage	Vcc	-0.5 to +4.0	V	
Input voltage	Vı	-0.5 to Vcc +0.5	V	
Output voltage	Vo	-0.5 to Vcc +0.5	V	
Storage temperature	Тѕтс	-55 to +125	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol		Value	Unit	Note		
raiametei	Symbol	Min	Тур	Max	Onit	Note	
Power supply voltage	Vcc	2.7	3.0	3.6	V	Vccif = Vccrf	
Input voltage	Vi	GND	_	Vcc	V		
Operating temperature	Та	-40	_	+85	°C		

WARNING: Recommended operating conditions are normal operating ranges for the semiconductor device. All the device's electrical characteristics are warranted when operated within these ranges.

Always yse semiconductor devices within the recommended operating conditions. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with repect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representative beforehand.

■ ELECTRICAL CHARACTERISTICS

D		Coursels ad	Condition		Value		11:4	
Paramete	er	Symbol	Condition	Min.	Тур.	Max.	Unit	
Device comply com	1 *1	Iccif	fin _{IF} = 500MHz, fosc = 12MHz	_	3.0	_	A	
Power supply curr	rent '	Iccrf	finrf = 2000MHz, fosc = 12MHz	_	6.0	_	- mA	
Device coving over		IpsıF	Vccif current at PSif ="L"	_	-	10	^	
Power saving curr	ent	Ips _{RF}	Vccrf current at PSif/rf ="L"	_	_	10	μΑ	
	finıғ	finıғ	IF-PLL	50	_	500		
Operating frequency			RF-PLL	100	_	2000	MHz	
ricquerioy	OSCin	fosc	min. 500mVp-p	3	_	40		
	finıғ	VfinıF	IF–PLL, 50Ω termination	-10	-	+2	dBm	
Input sensitivity	fin _{RF}	Vfinre	RF–PLL, 50Ω termination	-10	_	+2	dBm	
	OSCin	Vosc		500	-	Vcc	mVp-p	
	Data,	ViH	Schmitt trigger input	Vccx0.7+0.4	_			
Input voltage	Clock, LE	VIL	Schmitt trigger input	_	-	Vccx0.3-0.4	V	
	PS _{IF} ,	VIH		Vccx0.7	_		V	
	PSRF	VIL		-	_	Vccx0.3	, v	
	Data,	Іін		-1.0		+1.0		
Input current	Clock, LE, PS _{IF} , PS _{RF}	IιL		-1.0	-	+1.0	μΑ	
	000:	Ін		0	_	+100		
	OSCin	IIL		-100	_	0	μΑ	
	1.5%	Vон		Vcc-0.4	_		.,	
0	LD/fout	Vol		_	_	0.4	V	
Output voltage	Doif,	VDOH		Vcc-0.4	_		.,	
	Dorf	V _{DOL}		_	_	0.4	V	
High impedance cutoff current	Doif, Dorf	loff		_	-	1.1	μΑ	
	15"	Іон	Vcc = 3.0V	_	_	-1.0		
	LD/fout	loL	Vcc = 3.0V	1.0	_	_	mA	
Output current	Doif,	I _{DOH}		_	-6.0 ^{*2}	_		
	DORF	IDOL	Vcc = 3.0V, Vdol = 1.0V	_	-10.0*2	_	mA	

^{*1:} Conditions ; $Vcc_{IF/RF} = 3V$, Ta = 25°C, in locking state.

^{*2:} Conditions ; $Ta = 25^{\circ}C$

■ FUNCTIONAL DESCRIPTIONS

The divide ratio can be calculated using the following equation:

$$f_{VCO} = \{(P \times N) + A\} \times f_{OSC} \div R \quad (A < N)$$

fvco: Output frequency of external voltage controlled ocillator (VCO)

P: Preset divide ratio of dual modulus prescaler (16 or 32 for IF-PLL, 64 or 128 for RF-PLL)

N: Preset divide ratio of binary 11-bit programmable counter (5 to 2,047)

A: Preset divide ratio of binary 7-bit swallow counter ($0 \le A \le 127$)

fosc: Reference oscillation frequency

R: Preset divide ratio of binary 14-bit programmable reference counter (5 to 16,383)

Serial Data Input

Serial data is entered using three pins, Data pin, Clock pin, and LE pin. Programmable dividers of IF/RF–PLL sections, programmable reference dividers of IF/RF PLL sections are controlled individually. Serial data of binary data is entered through Data pin.

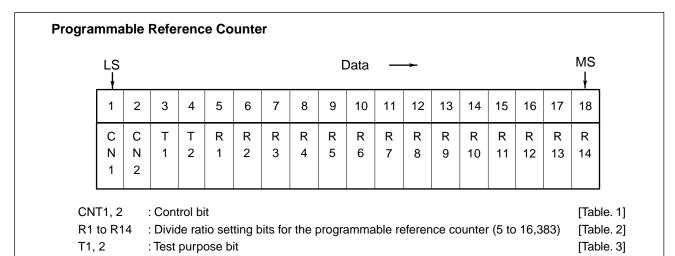
On rising edge of clock, one bit of serial data is transferred into the shift register. When load enable signal is high, the data stored in the shift register is transferred to one of latch of them depending upon the control bit data setting.

Table1. Control Bit

Con	trol bit	Destination of serial data
CN1	CN2	Destination of serial data
L	L	The programmable reference counter for the IF-PLL.
Н	L	The programmable reference counter for the RF-PLL.
L	Н	The programmable counter and the swallow counter for the IF-PLL
Н	Н	The programmable counter and the swallow counter for the RF-PLL

Shift Register Configuration

NOTE: Data input with MSB first.



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LŞ									Data	_												MS
<u> </u>										I		1						l	ı	I	I	<u> </u>
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23
С	С	L	S	F	Α	Α	Α	Α	Α	Α	Α	N	N	N	N	N	N	N	N	N	N	N
N	Ν	D	W	С	1	2	3	4	5	6	7	1	2	3	4	5	6	7	8	9	10	11
1	2	S																				
		CNT	1, 2	: (Contro	ol bit														[Tabl	le. 1]	
		N1 to	N14	: [Divide	ratio	settir	ng bits	s for tl	he pro	ogran	nmabl	le cou	inter ((5 to 2	2,047)			[Tabl	le. 4]	
		A1 to	A7	: [Divide	ratio	settir	g bits	s for tl	he sw	allow	coun	iter (0	to 12	27)					[Tabl	le. 5]	
SW : Divide ratio setting bit for the prescaler (16/17 or 32/33 for the IF-PLL, 64/65 OR 128/129 for the RF-PLL)																						
		FC : Phase control bit for the phase detector [Table. 7]																				
		LDS : LD/fout signal select bit [Table. 8]																				

Table2. Binary 14-bit Programmable Reference Counter Data Setting

Divide ratio (R)	R 14	R 13	R 12	R 11	R 10	R 9	R 8	R 7	R 6	R 5	R 4	R 3	R 2	R 1
5	0	0	0	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	0	0	0	1	1	0
•		•												
16383	1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.

Table.3 Test Purpose Bit Setting

T 1	T 2	LD/fout pin state
L	L	Outputs fr _i F.
Н	L	Outputs frrf.
L	Н	Outputs fp _{IF} .
Н	Н	Outputs fpre.

Table.4 Binary 11-bit Programmable Counter Data Setting

Divide ratio (N)	N 11	N 10	N 9	N 8	N 7	N 6	N 5	N 4	N 3	N 2	N 1
5	0	0	0	0	0	0	0	0	1	0	1
6	0	0	0	0	0	0	0	0	1	1	0
	•		•	•	•		•				
2047	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 5 is prohibited.

Table.5 Binary 7-bit Swallow Counter Data Setting

Divide ratio (A)	A 7	A 6	A 5	A 4	A 3	A 2	A 1
0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	1
·	•	•	•	•	•	•	
127	1	1	1	1	1	1	1

Note: • Divide ratio (A) range = 0 to 127

Table. 6 Prescaler Data Setting

		SW = "H"	SW = "L"
Prescaler	IF-PLL	16/17	32/33
divide ratio	RF-PLL	64/65	128/129

Table. 7 Phase Comparator Phase Switching Data Setting

	FC = H	FC = L
fr > fp	Н	L
fr = fp	Z	Z
fr < fp	L	Н
VCO polarity	(1)	(2)

Note: • Z = High-impedance

• Depending upon the VCO and LPF polarity, FC bit should be set.

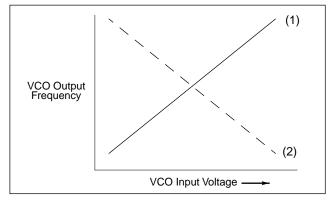
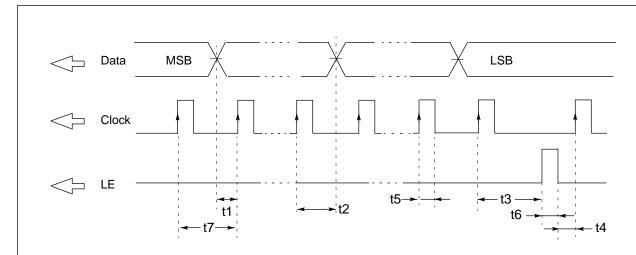


Table. 8 LD/fout Output Select Data Setting

LDS	LD/fout output signal	
Н	fout (frif/rf, fpif/rf) signals	
L	LD signal	

Serial Data Input Timing

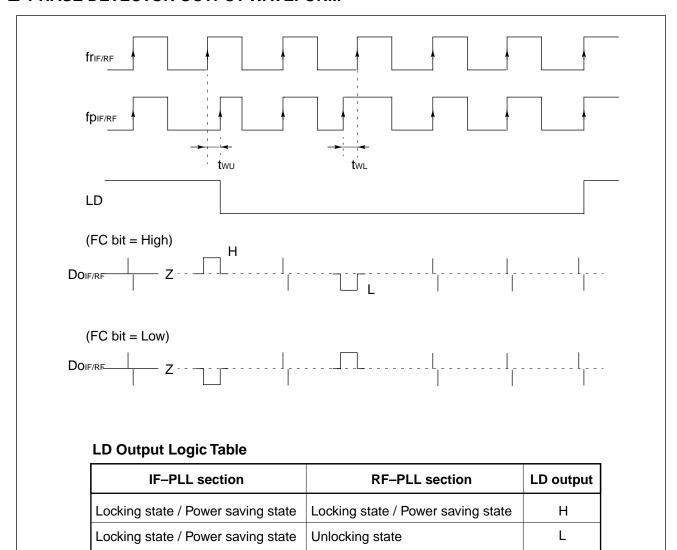


On rising edge of the clock, one bit of the data is transferred into the shift

Parameter	Min	Тур	Max	Unit
t1	20	_	_	ns
t2	20	_	_	ns
t3	30	_	_	ns
t4	20	_	_	ns

Parameter	Min	Тур	Max	Unit
t5	30	_	-	ns
t6	100	_	-	ns
t7	100	_	1	ns

■ PHASE DETECTOR OUTPUT WAVEFORM



Note: • Phase error detection range = -2π to $+2\pi$

Unlocking state

Unlocking state

- Pulses on DoiF/RF signals are output to prevent dead zone.
- LD output becomes low when phase error is two or more.
- LD output becomes high when phase error is twL or less and continues to be so for three cycles or more.

Unlocking state

Locking state / Power saving state

L

L

twu and twL depend on OSCin input frequency as follows.
 twu ≥ 8/fosc: i.e. twu ≥ 625ns when foscin = 12.8 MHz
 twL ≤ 16/fosc: i.e. twL ≤ 1250ns when foscin = 12.8 MHz

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■ POWER SAVING MODE (INTERMITTENT MODE CONTROL CIRCUIT)

Setting a PS_{IF(RF)} pin to Low, IF-PLL (RF-PLL) enters into power saving mode resultant current consumption can be limited to 10µA (typ.). Setting PS pin to High, power saving mode is released so that the device works normally. In addition, the intermittent operation control circuit is included which helps smooth start up from stand by mode. In general, the power consumption can be saved by the intermittent operation that powering down or waking up the synthesizer. Such case, if the PLL is powered up uncontrolled, the resulting phase comparator output signal is unpredictable due to an undefined phase relation between reference frequency (fr) and comparison frequency (fp) and may in the worst case take longer time for lock up of the loop.

To prevent this, the intermittent operation control circuit enforces a limited error signal output of the phase detector during power up. Thus keeping the loop locked.

PS pin must be set "L" at Power-ON.

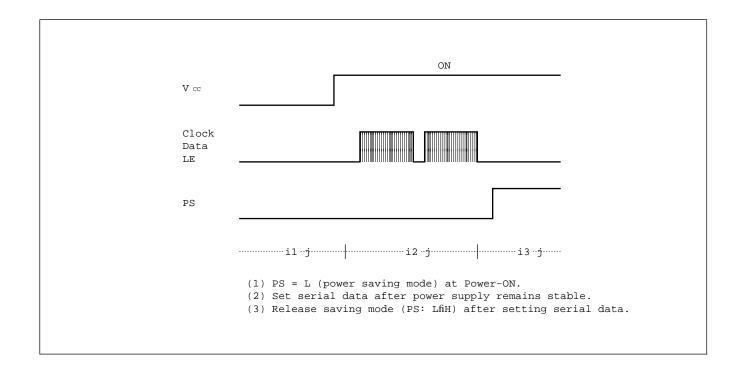
Allow 1 µs after frequency stabilization on power-up for exiting the power saving mode (PS: L to H) Serial data can be entered during the power saving mode.

During the power saving mode, the corresponding section except for indispensable circuit for the power saving function stops working, then current consumption is reduced to 10µA per one PLL section.

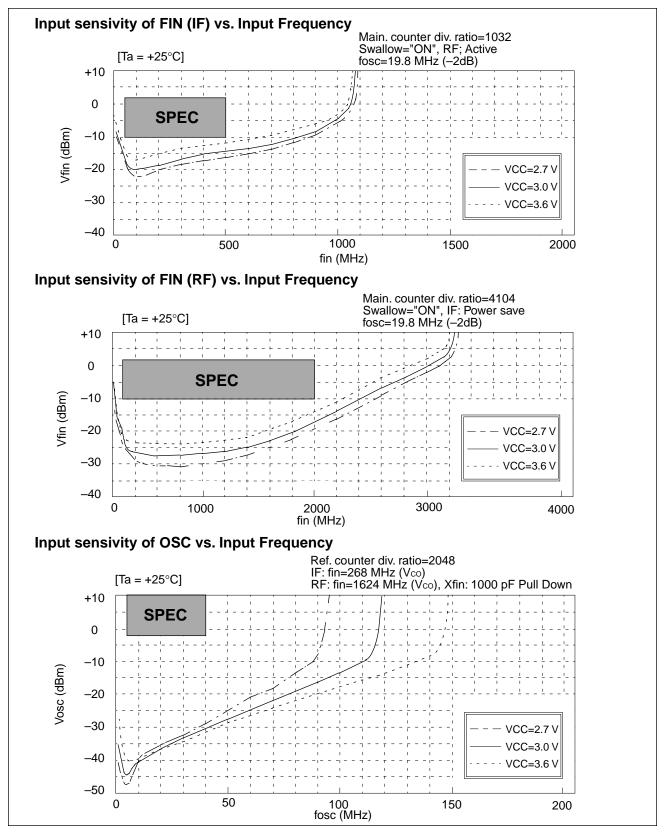
At that time, the Do and LD become the same state as when a loop is locking. That is, the Do becomes high impedance.

A VCO control voltage is naturally kept at the locking voltage which defined by a LPF's time constant. As a result of this, VCO's frequency is kept at the locking frequency.

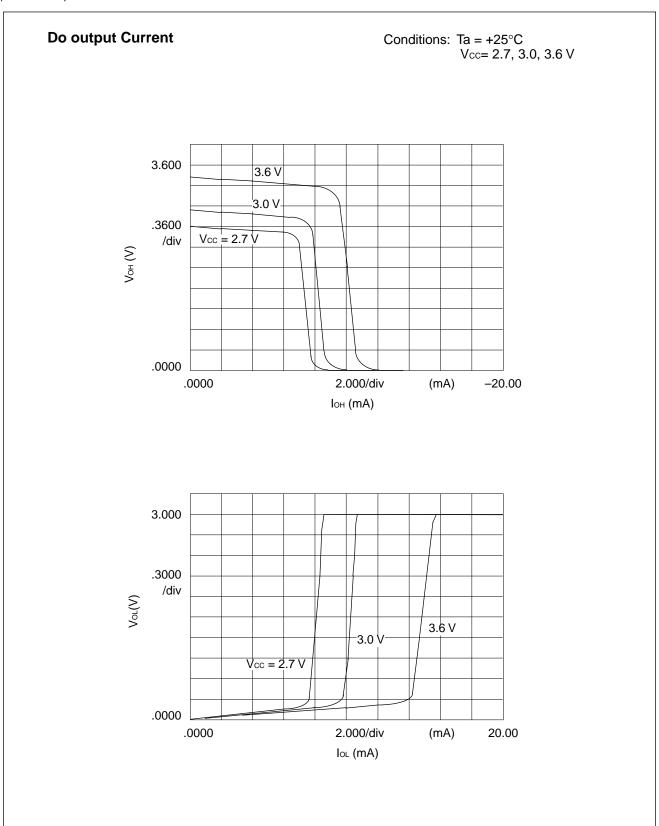
PSıF	PS _{RF}	IF-PLL counters	RF-PLL counters	OSC input buffer
L	L	OFF	OFF	OFF
Н	L	ON	OFF	ON
L	Н	OFF	ON	ON
Н	Н	ON	ON	ON



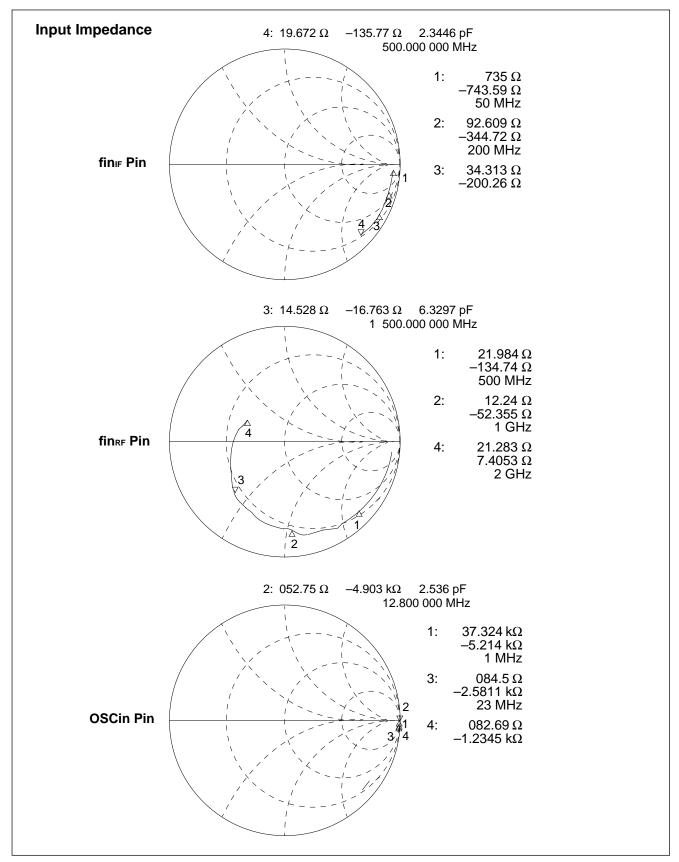
■ TYPICAL CHARACTERISTICS



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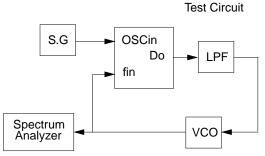


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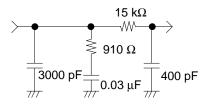


■ REFERENCE INFORMATION

Typical plots measured with the test circuit are shown below. Each plot shows lock up time, phase noise and reference leakage.



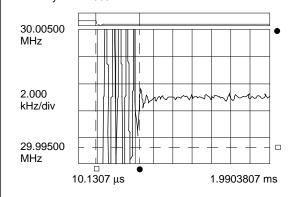
- fvco = 1835 MHz
- Kv = 87 MHz/v
- fr = 200 kHz
- fosc = 13 MHz
- LPF:



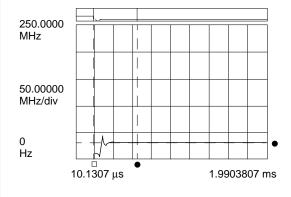
PLL Lock Up Time = 460 μs

 $(1797.6 \text{ MHz} \rightarrow 1872.4 \text{ MHz}, \text{ within } \pm 1 \text{kHz})$

 Δ MKr x : 460.02316 μ s y : -74.7998 MHz

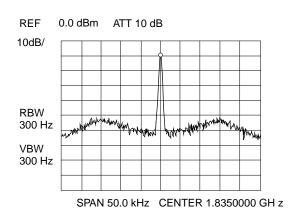


 Δ MKr x : 460.02316 μ s y : -74.7998 MHz



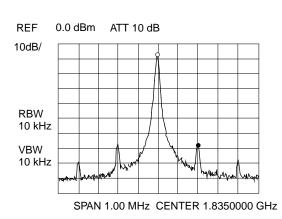
PLL Phase Noise

@ within loop band = 70.1 dBc/Hz

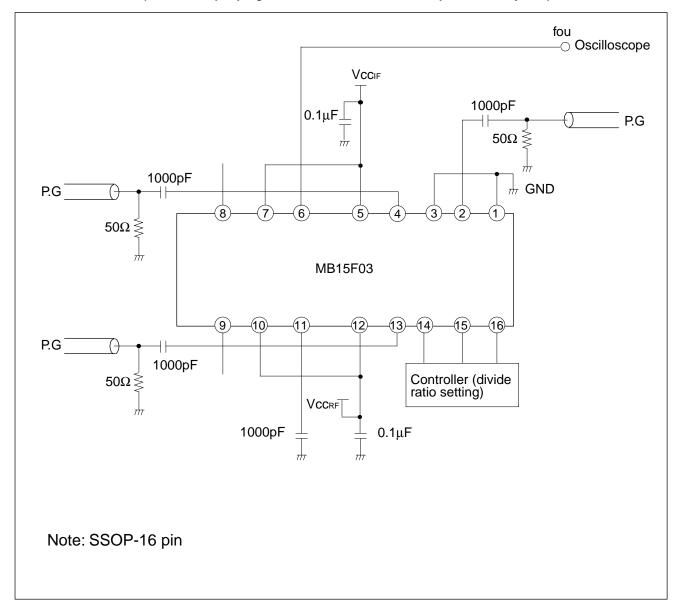


PLL Reference Leakage

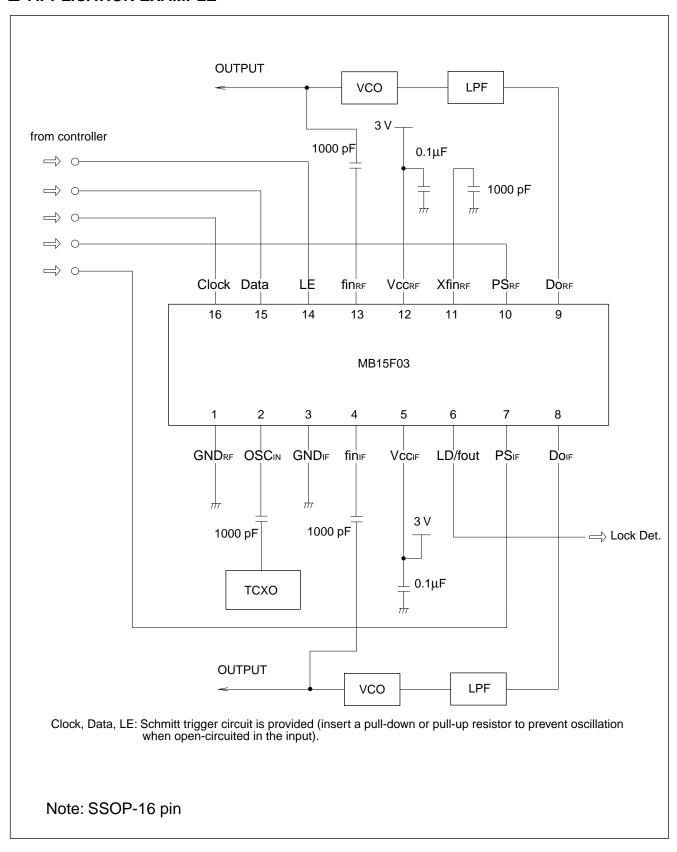
@ 200 kHz offset = 59 dBc



■ TEST CIRCUIT (Prescaler Input/programmable Reference Divider Input Sensitivity Test)



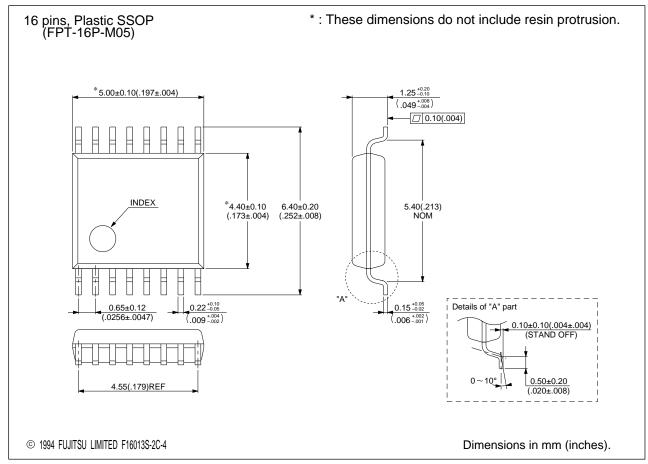
■ APPLICATION EXAMPLE



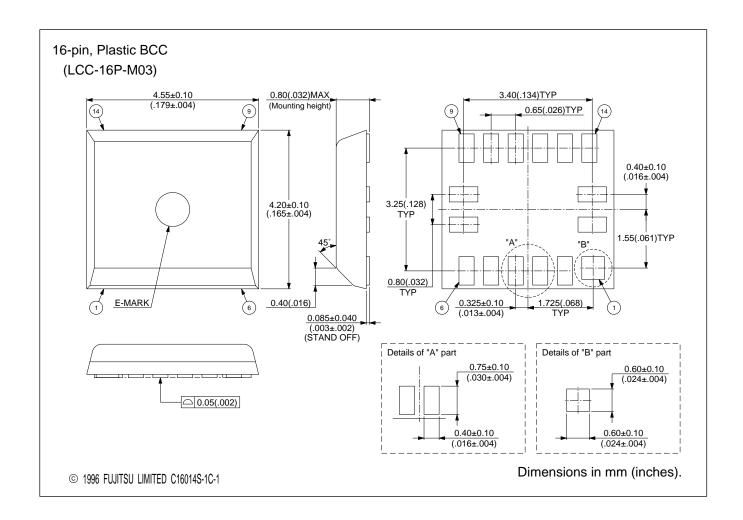
■ ORDERING INFORMATION

Part number	Package	Remarks
MB15F03 PFV	16 pin, Plastic SSOP (FPT-16P-M05)	
MB15F03 PV	16 pin, Plastic BCC (LCC-16P-M03)	

■ PACKAGE DIMENSIONS



(Continued)



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